APPLICA	BLE STAN	DARD			_									
	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE		-35 °C TO +105°C (NOTE1) STORAG			RATURE RANGE			-10 °	-10 °C TO +60°C (NOTE3)				
RATING			20% TO 80% (NOTE2) STORAG						40%	40% TO 70%			(NOTE3)	
					CURRE	ENT				3A				
	APPLICABLE CONNECTOR		DF59S-1P-FC DF59S-1P-C			sı	PECIFICA	TION	۸۵	NOTE	1)			
					VOLTAG	SE LU	L/C-UL	AC/DC 330V (I				101L4)		
							ÜV		TBD					
			0050	1510	<u> </u>		UV				TBD			
		1	SPEC	IFIC	AHO	NS_								
ITEM CONSTRUCTION			TEST METHOD			REQUIREMENTS						QT	AT	
		IVISITALI	V AND BY MEASURING IN	STDLIME	=NIT	ACCO	DDING T	O DBA	WING			X	TV	
			/ISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.						X	
												X	1^	
ELECTRIC CHARACTE CONTACT RESISTANCE DC6			DC6V MAX, 100mA.				MAX.					X	Τ-	
	NICAL CHA	RACTI	ERISTICS											
MECHANICAL 10TIN			OTIMES INSERTION AND EXTRACTION.				①50mΩ MAX.						-	
			REQUENCY 10 TO 55Hz, SINGLE AMPLITUDE				②NO DAMAGE, CRACK OR LOOSENESS OF PARTS. ①NO ELECTRICAL DISCONTINUITY OF 1 μ s.					+	+-	
I I			5mm, AT 10CYCLES FOR 3DIRECTION.				②NO DAMAGE, CRACK OR LOOSENESS OF PARTS.							
I I			0 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3										T -	
ENIVIRON	IMENITAL C	DIRECTIO	TERISTICS											
DAMP HEAT	IIVILIVIT (C		O AT 40 ± 2°C , 90 TO 95 %, 9	96 h.		①50m	Ω MAX.					Тх	Τ-	
(STEADY STATE) (AFTE			AFTER LEAVING THE ROOM TEMPERATURE FOR 1~2h.)				DAMAGE, CI	RACK O	R LOOSENE	SS OF	PARTS.			
		TEMPERA TIME	ATURE -55°C→ +85°C 30min→ 30min									X	-	
TEMPERATO	KE	UNDER 5 CYCLES.												
		,	ANSFERRING TIME OF THE T		,									
· · · · · · · · · · · · · · · · · · ·			R LEAVING THE ROOM TEMPERATURE FOR 1~2h.) REFLOW SOLDERING				FORMATIC	ON OF (CASE OF			X	+-	
SOLDERING		,	NUMBER OF REFLOW CYCLES : 2CYCLES MAX.				EXCESSIVE LOOSENESS OF THE					^		
		≪REFLOW AREA≫				TERMINALS.								
		DURATION ABOVE 220°C, 60sec. MAX. PEAK TEMPERATURE: 250°C, 10sec. MAX. «PRE-HEAT AREA» PRE-HEAT TEMPERATURE:150°C TO 180°C PRE-HEAT TIME:90sec.TO 120sec.												
		2) MANUAL SOLDERING												
SOLE			SOLDERING IRON TEMPERATURE :350±10°C, SOLDERING TIME : 3sec. NO STRENGTH ON CONTACT.											
			RING TEMPERATURE : 245°C ON OF IMMERSION :SOLDERING, FOR 5sec.			NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.						X	1-	
1		PERATURE	RISING BY CURRENT.											
NOTE2:NO C NOTE3:APPL		DITION OF	LONG TERM STORAGE FOR	UNUSED	PRODUC	TS BEF	OR PCB O	N BOAI	RD, AFTER	PCB E	BOARD	, OPER	RATING	
TEM	PERATURE ANI	TIDIMUH C	TY RANGE IS APPLIED FOR IN	ITERIM S	TRAGE D	URING	TRANSPO	RTATIC	N.					
COUN			ON OF REVISIONS		DESIG		ERN:3.0mm MIN FOR THE VOLTAGE. CHECKED				DATE			
		LOOKII III	ON OF REVIOIONS		DEGIC	SINED			OFFICIA	3.1231(2)			· · · ·	
REMARKS							APPRO'	VED	KI. AI	KIYAMA	١	12.	11. 14	
							CHECK	ŒD	OM. MI	YAMOT	0	12.	11.14	
Unless otherwise specified, refer			er to JIS C 5402 and IEC60512.			DESIGNED DRAWN		VED	KT. ISHII			12.	11. 13	
								KT.	KT. ISHII 1:		12.	11. 13		
Note QT:Q	ualification Tes	st AT:Ass	urance Test X:Applicable Test			DRAWING NO		ELC4-342887-				7-03		
HS.	SI	PECIFI	CATION SHEET P			NO.		DF59S-1S-V (24)						
	HIR	OSE EI	LECTRIC CO., LTD.		CODE	NO. CL66		.667-	7-0024-6-24			\triangle	1/1	
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